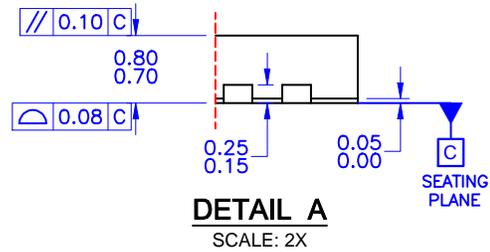
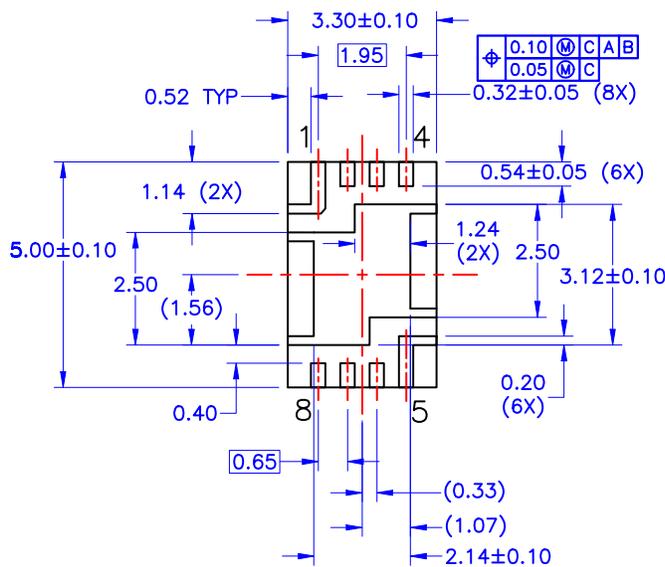
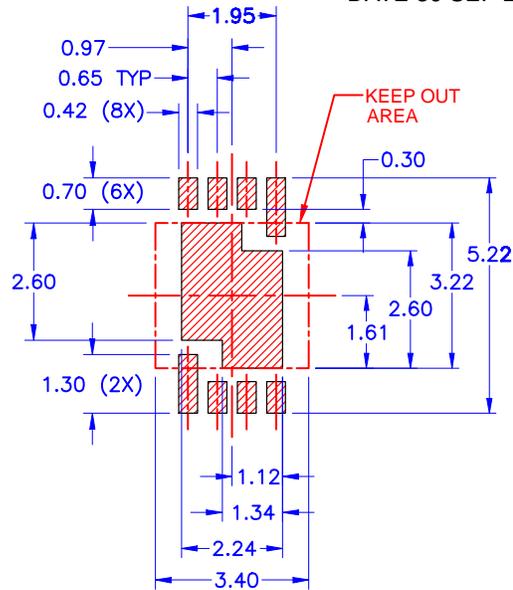
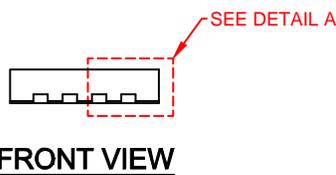
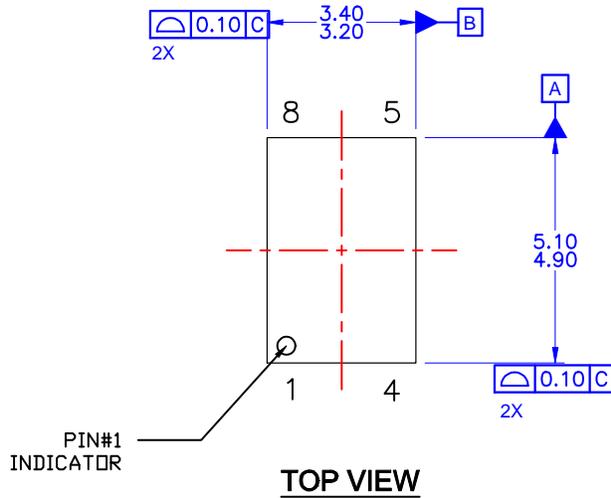




PQFN8 3.3X5, 0.65P
CASE 483AU
ISSUE O

DATE 30 SEP 2016



- NOTES: UNLESS OTHERWISE SPECIFIED
- A) DOES NOT FULLY CONFORM TO JEDEC REGISTRATION, MO229 DATED 8/2012.
 - B) ALL DIMENSIONS ARE IN MILLIMETERS.
 - C) DIMENSIONS DO NOT INCLUDE BURRS OR MOLD FLASH. MOLD FLASH OR BURRS DOES NOT EXCEED 0.10MM.
 - D) DIMENSIONING AND TOLERANCING PER ASME Y14.5M-1994.
 - E) IT IS RECOMMENDED TO HAVE NO TRACES OR VIAS WITHIN THE KEEP OUT AREA.

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NEW STANDARD:		
DESCRIPTION:	PQFN8 3.3X5, 0.65P	PAGE 1 OF 2

